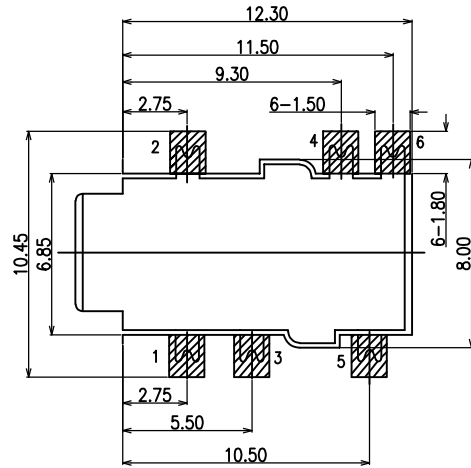
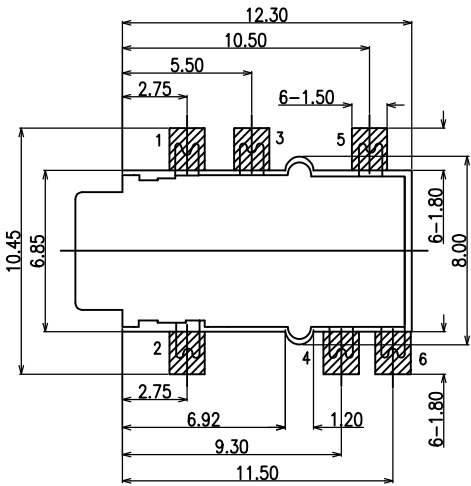


PROPRIETARY INFORMATION
COMPANY CONFIDENTIAL

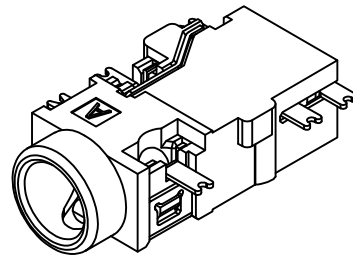
REV.	ECN NO.	DESCRIPTION	DESIGN	DATE
A		INITIAL	Liu Miao	2019.06.24



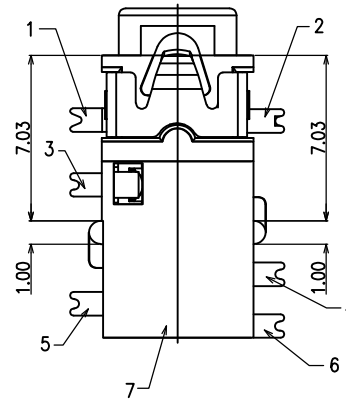
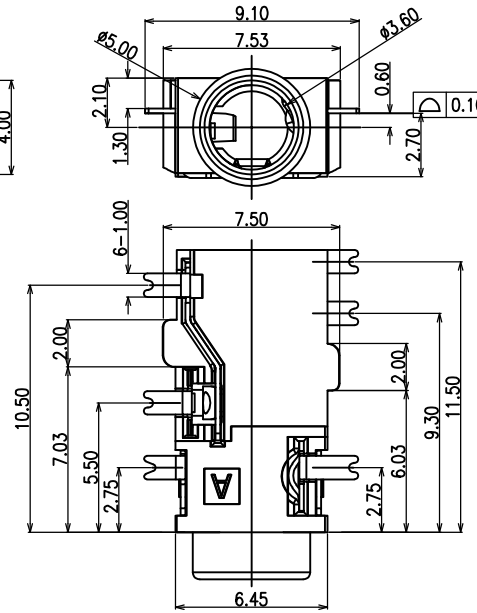
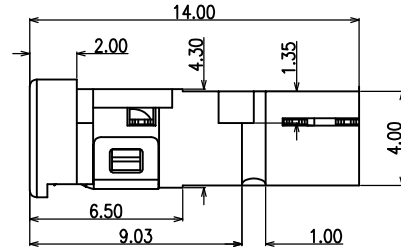
正贴 P.C.B LAYOUT
TOP VIEW



反贴 P.C.B LAYOUT
TOP VIEW

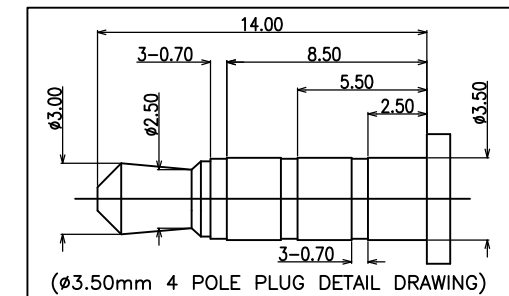
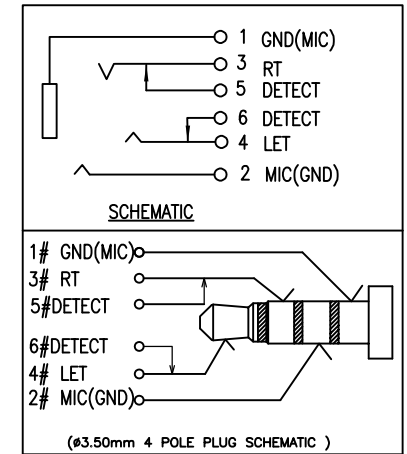


3D VIEW



NOTES:

- REQUEST OF THE SPECIFICATION:
 - CONTACT CURRENT RATING: 1A.;
 - CONTACT RESISTANCE: 100 mΩ MAX.;
 - INSULATION RESISTANCE: 100MΩ MIN.;
 - DIELECTRIC WITHSTANDING: 500V AC MIN.;
 - DURABILITY: 5,000 CYCLES MIN.;
 - CONNECTOR MATING FORCES: 30N MAX.;
 - CONNECTOR UNMATING FORCES: 3N MIN.;



7	HOUSING	1	HIGHT TEMPERATURE PLASTIC COLOR BLACK	
6	TERMINAL 6#	1	STAINLESS STEEL; NICKEL UNDER PLATING OVERALL,GOLD FLASH ON SOLDER AREA	T=0.20
5	TERMINAL 5#	1	STAINLESS STEEL; NICKEL UNDER PLATING OVERALL,GOLD FLASH ON SOLDER AREA	T=0.20
4	TERMINAL 4#	1	COPPER ALLOY; NICKEL UNDER PLATING OVERALL,GOLD FLASH ON SOLDER AREA ;GOLD FLASH ON CONTACT AREA	T=0.20
3	TERMINAL 3#	1	STAINLESS STEEL; NICKEL UNDER PLATING OVERALL,GOLD FLASH ON SOLDER AREA ;GOLD FLASH ON CONTACT AREA	T=0.20
2	TERMINAL 2#	1	COPPER ALLOY; NICKEL UNDER PLATING OVERALL,GOLD FLASH ON SOLDER AREA ;GOLD FLASH ON CONTACT AREA	T=0.20
1	TERMINAL 1#	1	STAINLESS STEEL; THE BOTTOM OF THE NICKEL; THE WHOLE GOLD FLASH PLATING.	T=0.20
ITEM	NAME	Q'TY	DESCRIPTION	NOTE

UNLESS OTHERWISE SPECIFIED TOLERANCES

DECIMALS:		ANGLES:	
DIM	TOL	DIM	TOL
X.X	±0.35	X.	±2'
X.XX	±0.30	X.X	±1'
X.XXX	±0.20	X.XX	—
X.XXX	±0.10	X.XXX	—

WFDconn

深圳市旺富达电子有限公司
Shenzhen WFD Electronics Co.Ltd..

DWG NO.	JH-CP-RD-0073
DESIGN:	Liu Miao 2019.06.24
CHECK:	SIMON
APPROVED	DAVID 2019.06.24

PART NAME:		PHONE JACK	
PART NO.		MPJ-06C36-06-G/S-003	
REV.	UNIT:	SHEET:	☉
A	mm	1/1	